



REVISION RECORD

Rev	Date	NO.	Description of Revision History
00	2018-10-24		New Publication

地址：湖北省随州市经济开发区深圳工业园

ADD: SHENZHEN INDUSTRIAL PARK, SUIZHOU ECONOMIC DEVELOPMENT ZONE, HUBEI

SALES TEL: 0722-7509016, FAX: 0722-7509036 URL: www.sztkd.com

FMT: TH-QW-RD2-23 Ver: C0

**1. 石英晶体参数规格 QUARTZ CRYSTAL UNIT SPECIFICATION**

- ※描述 Description : Quartz Crystal
 ※产品型别 Product Type : SX-3225
 ※水晶切割模式 Crystal cutting type : AT-CUT
 ※测量设备 Measure equipment : S&A 250B
 ※电气特性 Electrical Characteristics

	项目 Item	代码 Symbol	电气特性规格 Electrical Specification				备注 Notes
			下限 Min.	中心 Typ.	上限 Max.	单位 Units	
1	一般频率 Nominal Frequency	F0	20.000000			MHz	
2	振荡模式 Oscillation Mode	-	Fundamental			-	
3	负载电容 Load Capacitance	CL	10			pF	
4	频率公差 Frequency Tolerance	-	-10	-	10	ppm	At 25°C±3°C
5	等效串联电阻 Equivalent Series Resistance	ESR	-	-	40	Ω	
6	驱动功率 Drive Level	DL	-	-	100	μW	
7	频率稳定度 Frequency Stability	TC	-30	-	30	ppm	Over Operating Temp. Range (Ref. to 25°C)
8	动作温度 Operating Temperature	-	-40	-	85	°C	
9	储存温度 Storage Temperature	-	-40	-	85	°C	
10	年老化率 Aging	-	-3	-	3	ppm	Per Year
11	绝缘阻抗 Insulation Resistance	-	500	-	-	MΩ	At DC 100V
12	并联电容 Shunt Capacitance	C0	-	-	3	pF	

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备注 Notes:

1. 超声波清洗 Ultrasonic cleaning

一般的清洁液或超声波清洗方法可以用来清洗我们的产品。但是，在某些情况下，超声波清洗机在我们产品的振荡频率上会产生共振，从而使器件的电气特性恶化，甚至损坏器件的整体结构。因此，建议超声波清洗前进行验证测试。General cleaning solutions or ultrasonic cleaning method may be used to clean our products. However, under certain circumstances, ultrasonic cleaning machine could generate resonance at the oscillation frequency of our products and thus deteriorate the electrical characteristics in devices, and even damage the overall structure of devices. Therefore, verification test is recommended before cleaning.

2. 超声波焊接 Ultrasonic welding

避免使用超声波焊接进行安装和加工，这种方法有可能使晶体产品内部产生过大的振动扩散，成为特性退化而不振动的的原因。Avoid mounting and processing by Ultrasonic welding this method has a possibility of an excessive vibration spreading inside the crystal products and becoming the cause of characteristic deterioration and not oscillating.

3. 储存温度说明 Storage temperature description

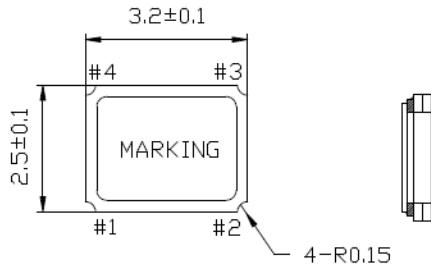
储存温度仅适用于产品，而包装材料储存温度 $5^{\circ}\text{C}\sim 40^{\circ}\text{C}$ 。Storage Temperature is only for the product itself, the temperature for the packing material is $5^{\circ}\text{C}\sim 40^{\circ}\text{C}$.

4. 手工焊建议条件 Recommended conditions for manual welding

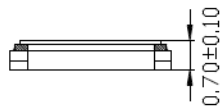
温度： $350\pm 10^{\circ}\text{C}$ ，时间：3秒 Max，次数：2次 Max。Temperature: $350\pm 10^{\circ}\text{C}$, Time: 3 sec max, Re-solder times: twice max.



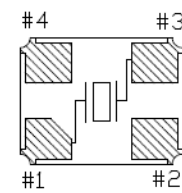
2. 产品图纸 DIMENSIONS (Units:mm)



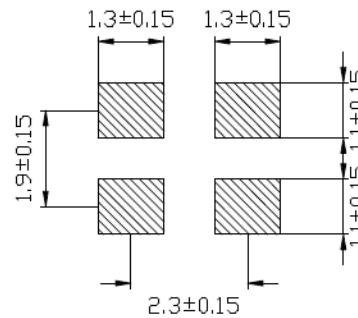
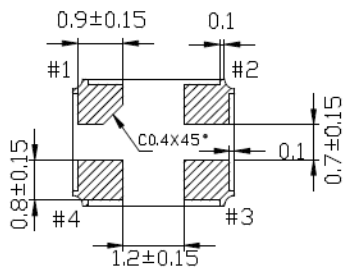
PIN CONNECT	
1,3	Crystal
2,4	GND



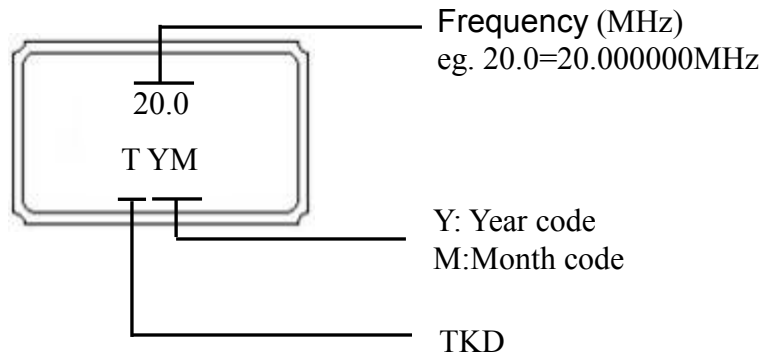
<TOP VIEW>



LAND PATTERN<REFERENCE>



3. 印字 MARKING

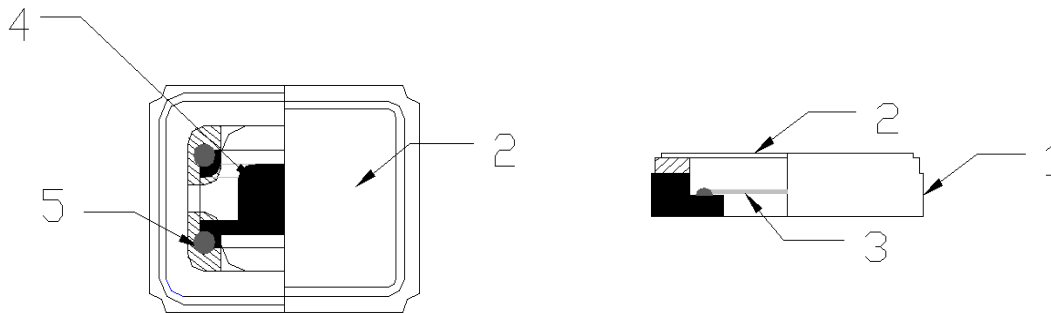


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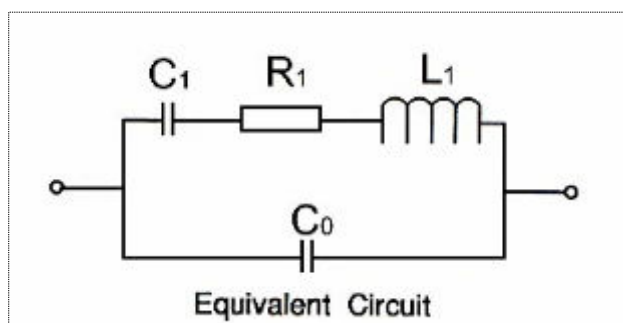
Code: A B C D E F G H J K L M

4. 内部结构产品图纸 INSIDE STRUCTURE



No.	组件 COMPONENTS	材料成份 MATERIALS
1	基座 Package	陶瓷 Ceramic (Al ₂ O ₃)
2	外壳 LID	KV 合金 KV (Fe/Co/Ni)
3	水晶片 Crystal blank	二氧化硅 SiO ₂
4	电极 Electrode	贵金属银 Noble Metal (Ag)
5	接着剂 Adhesive	树脂、银粉 Resin、Ag

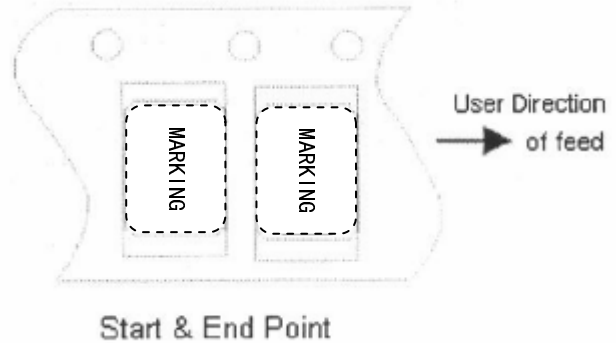
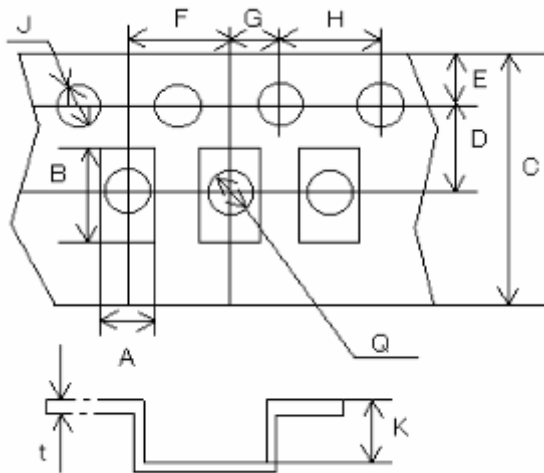
5. 等效电路图 EQUIVALENT CIRCUIT





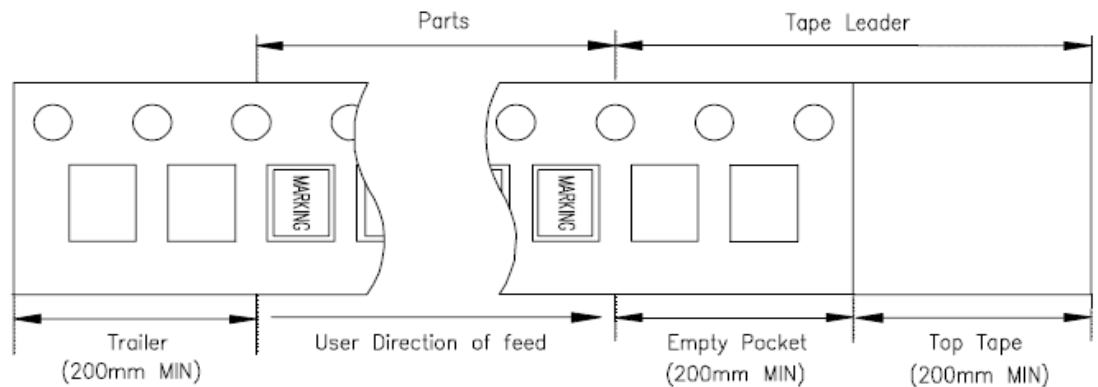
6. 包装 PACKING (Units:mm)

※载带类型 CARRIER TYPE

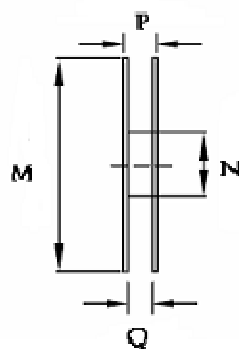
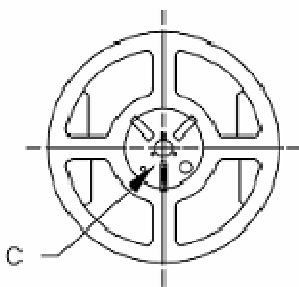


A	B	C	D	E	F	G	H	J	K	t
2.7	3.4	8.0	3.5	1.75	4.0	2.0	4.0	1.55	1.4	0.25

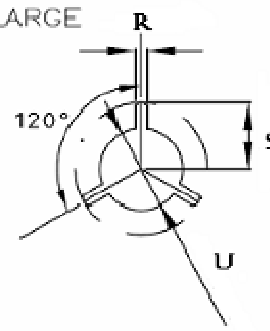
备注 REMARK:



※圆卷 REEL: 3000 PCS/Reel



C.ENLARGE



M	N	P	Q	R	S	U
178.0	60.2	11.5	8.0	2.5	11.0	13.0

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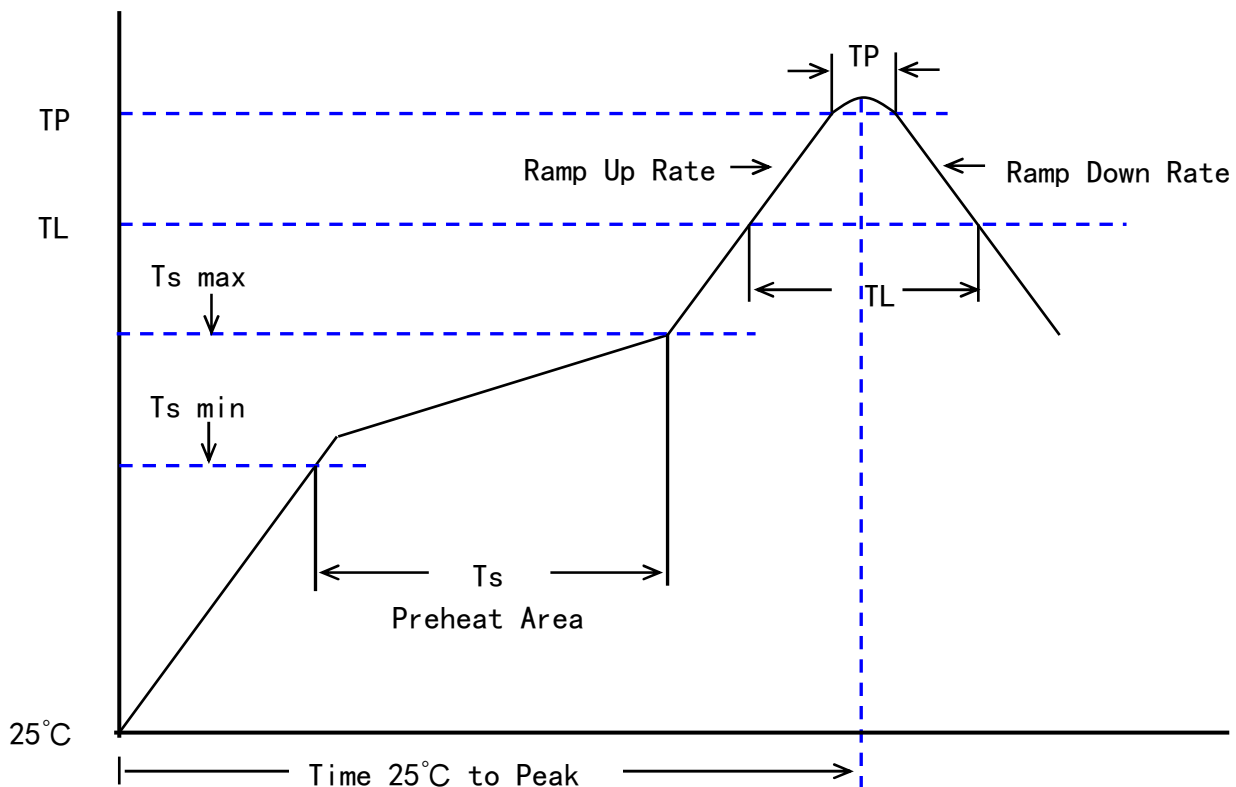
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7. 回流焊温度曲线 REFLOW PROFILES

参考标准 REFER: JEDEC J-STD-020D

Profiles Feature	Pb-Free Assembly
Preheat/Soak	
Temperature Min (Ts min)	150°C
Temperature Max (Ts max)	200°C
Time (Ts) from (Ts min to Ts max)	60-120 seconds
Ramp-up rate (TL to TP)	3°C/second max.
Liquidous temperature (TL)	217°C
Time (TL) maintained above TL	60-150 seconds
Peak/Classification Temperature (TP)	260±5°C
Time within 5°C of actual Peak Temperature (TP)	20~40 seconds
Ramp-down rate (TP to TL)	6°C/second max.
Time 25 ° C to peak temperature	8 minutes max.
Suggest reflow times	3 Times max



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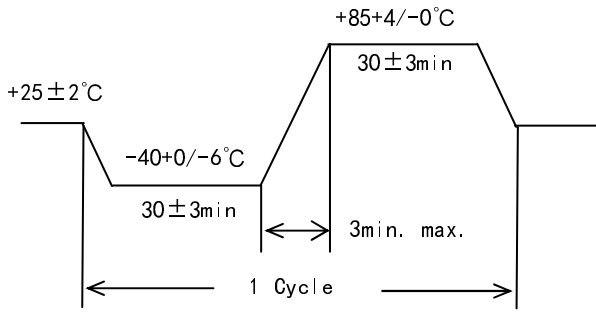
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8. 可靠性试验 RELIABILITY SPECIFICATION

参考标准 REFER		JIS C 6701	
NO.	项目 ITEM	测试条件 CONDITIONS	测试标准 Criteria
1	跌落 FREE FALL	从75cm位置高度, 自由跌落在木板上, 连续3次 FREE DROPPING FROM 75 cm HEIGHT 3 TIMES ON A HARD	A. C
2	振动 VIBRATION	振动频率: 10~55 Hz, 振幅: 1.5mm±15%, 时间: 每个方位三面(X、Y、Z)各振动2小时 FREQUENCY: 10~55Hz AMPLITUDE (TOTAL EXCURSION): 1.5mm±15%, SWEEP TIME: 1MIN, 3 DIRECTION(X, Y, Z) EACH FOR 2 Hrs.	A. C
3	冷热冲击 TEMPERATURE CYCLE	晶体放入试验箱中, 高、低温循环100次 THE CRYSTAL UNIT SHALL BE SUBJECTED TO 100 SUCCESSIVE CHANGE OF TEMPERATURE CYCLES 	A. C. H
4	气密性(大漏) GROSS LEAK	标准件自动压差比对测试 STANDARD SAMPLE FOR AUTOMATIC GROSS LEAK DETECTOR	E
4	气密性(小漏) FINE LEAK	氦气压力标准: 5.0~5.5Kg/cm ² , 加压时间: 2小时 HELIUM BOMBING 5.0~5.5 Kg _f / cm ² , FOR 2 HOURS.	F
5	可焊性 SOLDERABILITY	温度: 260±5°C, 浸锡时间: 2±0.6秒 THE LEAD IS IMMERSSED IN A 260±5°C SOLDER BATH WITHIN 2±0.6 SECONDS.	G
6	高温高湿 HIGH TEMP. & HUMIDITY	温度: 60°C ± 2°C, 湿度: 90%~95%, 保持时间: 500个小时 STORED AT 60±2°C AND HUMIDITY 90~95% FOR 500±12 H.	A. C. D. H
7	高温存储 HIGH TEMPERATURE STORAGE	高温温度: 85°C ± 2°C, 时间: 720±12个小时 如果客户的温度要求是高于标准, 则必须根据客户的要求测试 STORED AT 85±2°C FOR 720±12H. If Customer's temperature request is higher than the standard, Temperature test must be done for customer requirements	A. C. H
8	低温存储 LOW TEMPERATURE	低温温度: -40°C ± 2°C, 时间: 500±12个小时 STORED AT -40±2°C FOR 500±12H. 如果客户的温度要求是低于标准, 则必须根据客户的要求测试	A. C. H

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	STORAGE	If Customer's temperature request is lower than the standard, Temperature test must be done for customer requirements	
9	折板弯曲试验 TERMINAL STRENGTH	<p>弯曲度：3mm, 保持时间：5sec, 速度：0.5mm/sec SHALL BE PRESSURIZED AT A SPEED OF APPROX. 0.5mm/sec IN THE DIRECTION INDICATED BY THE ARROW UNTIL THE BENDING WIDTH REACHES 3mm AND HELD FOR 5 SECONDS.</p>	A. C
10	折板推力试验 STICKING TENDENCY	<p>荷重：10N, 保持时间：10秒, 治具：R0.5 (制品侧边位置) A R0.5 JIG SHALL BE USED TO APPLY A 10N DEAD LOAD IN THE DIRECTION INDICATED BY THE ARROW TO THE ELEMENT AND RETAIN IT FOR 10 SECONDS.</p>	A. C
11	本体荷重试验 ELEMENT ASSEMBLY STRENGTH	<p>荷重：10N, 保持时间：10秒, 治具：R0.5 (制品中心位置) A R0.5 PRESSURIZED BAR SHALL BE USED TO APPLY A 10N LOAD IN THE CENTER OF ELEMENT AND RETAIN IT FOR 10 SECONDS.</p>	A. C

SPECIFICATIONS

A	FREQUENCY CHANGE PERMITTED.	$\Delta F \leq 5\text{PPM}$
B	FREQUENCY CHANGE PERMITTED.	$\Delta F \leq 10\text{PPM}$
C	EQUIVALENT SERIES RESISTANCE CHANGE PERMITTED.	$\Delta CI \leq 5\Omega$ or 15%
D	INSULATION RESISTANCE	$> 500\text{M}\Omega$
E	PRESSURE GAP LESS THAN	$< 1 \times 10^{-4} \text{ Pa} \cdot \text{m}^3 / \text{sec}$
F	LEAK RATE LESS THAN	$< 1 \times 10^{-9} \text{ Pa} \cdot \text{m}^3 / \text{sec}$
G	A NEW UNIFORM COATING OF SOLDER SHALL COVER A MINIMUM 95% OF THE SURFACE	
H	THEN $25 \pm 2^\circ\text{C}$ OVER 2Hr BEFORE TESTING	

Remark:

※ Each test done independently

※ Measurement condition: Electrical characteristics measured by S&A250B or equivalent.

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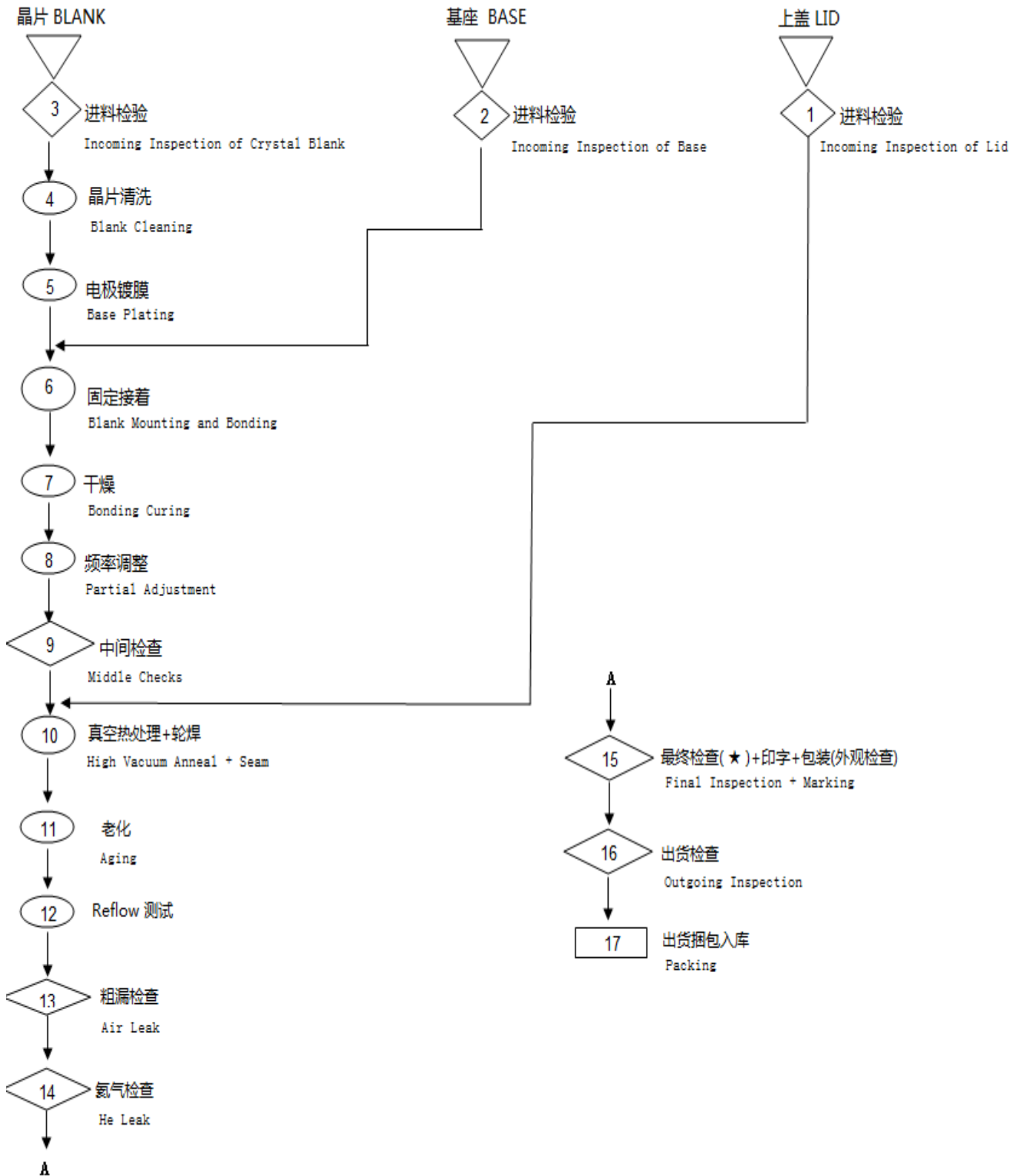
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9. 工艺流程图 FLOW CHART



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10. 有害物质含量声明 HARMFUL SUBSTANCE CONTENT STATEMENT

随州泰华电子科技有限公司 SX-3225 产品

有毒有害物质或元素的名称及含量表

材料名称	有毒有害物质或元素						备注
	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr(VI))	多溴联苯 (PBB)	多溴二苯醚 (PBDE)	
BLANK	ND	ND	ND	ND	ND	ND	
Package	ND	ND	ND	ND	ND	ND	
LID	ND	ND	ND	ND	ND	ND	
Electrode	ND	ND	ND	ND	ND	ND	
Adhesive	ND	ND	ND	ND	ND	ND	
... ..							
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拆分部件 n							

○：表示该有毒有害物质在该部件所有均质材料中的含量均在 SJ/T11363-2006 规定的限量要求以下
 ×：表示该有毒有害物质至少在该部件的某一均质材料中的含量超出 SJ/T11363-2006 规定的限量要求。
 (供应商应将其原材料按要求进行拆分，并按照此表格进行详细标注, 对不能满足标准要求的零部件进行具体的原因描述)